

<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT(S)</b>  Page 1 of 2	Docket: END5311USNP	Appln. No. 10/825,952
	Applicant: Inder Raj S. Makin	
	Filed: April 16, 2004	Group: 3768

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Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.